

# L-Band, GaN/SiC, RF Power Transistor

960 - 1220 MHz | 90W typ | 70% Efficiency typ | 18 dB Gain typ | 75 V | 32µs Pulse Length, 4% Duty Cycle

IGN0912S80HV and IGN0912S80HVS are high power GaN-on-SiC RF power transistors that have been designed to suit the unique needs of IFF and TACAN/DME systems. They operate over the full 960 - 1220 MHz frequency range. Under 32µs, 4% duty cycle pulse conditions, they supply a minimum of 80 W of peak output power. They operate from a 75V supply voltage. For optimal thermal efficiency, the transistors are housed in a metal-based package with an epoxy-sealed ceramic lid.

### **FEATURES**

- GaN on SiC HEMT Technology
- Output Power >80W
- Pre-matched Input Impedance
- High Efficiency up to 70%
- 100% RF Tested Under 32µs, 4% duty cycle pulse conditions
- RoHS and REACH Compliant

### **APPLICATIONS**

IFF and TACAN/DME Systems



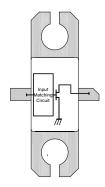


Table 1. RF Electrical Characteristics in Broadband Test Fixture (Case temperature = 30 °C unless otherwise stated)
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Parameter	Symbol	Min	Тур	Мах	Units	Test Conditions
Gain	G	16	17.5	19	dB	P <sub>out</sub> = 80W
Drain Efficiency	η	50	65	75	%	f = 960, 1090, 1220 MHz
Pulse Droop	D	-0.2	-0.05	+0.1	dB	- 32μs pulse length, 4% duty cycle
Load Mismatch Stability	VSWR-S		2:1			
VSWR Withstand	VSWR-LMT		5:1			$V_{\rm DS} = 75V, I_{\rm DS} = 8mA$

Note: Consult Integra Technologies Application Note 001 for information on how RF output power and pulse droop are measured.

# IGN0912S80HV | RF Power Transistor IGN0912S80HVS



#### Table 2. Absolute Maximum Ratings (Not Simultaneous)

Parameter	Symbol	Value	Units	Test Conditions
DC Drain-Source Voltage	V <sub>DS</sub>	150	V	25 ºC
DC Gate-Source Voltage	V <sub>GS</sub>	-8 to +1.0	V	25 ºC
DC Drain Current	I <sub>D</sub>	2	A	25 ºC
DC Gate Current	I <sub>G</sub>	2	mA	25 ºC
RF Input Power	P <sub>RF,IN</sub>	3	W	25 ºC
Operating Channel Temperature	T <sub>j</sub>	-55 to +225	٥C	
Storage Temperature	T <sub>stg</sub>	-62 to +150	٥C	
Soldering Temperature	T <sub>SOLDER</sub>	260 for 60s	٥C	

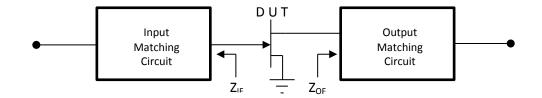
Note: Operation outside the limits given in this table may cause permanent damage to the transistor

#### Table 3. DC Electrical Characteristics (Case temperature = 25 °C unless otherwise stated)

Parameter	Symbol	Min	Тур	Мах	Units	Test Conditions
Gate Pinch-Off Voltage	V <sub>P</sub>	-5.0			V	$V_{_{\rm DS}} = 75$ V, $I_{_{\rm DS}} = 1$ mA
Quiescent Gate Voltage	V <sub>Q</sub>		-2.8		V	$V_{_{\rm DS}} = 75$ V, $I_{_{\rm DS}} = 8$ mA

#### **Table 4. Test Fixture Source & Load Impedances**

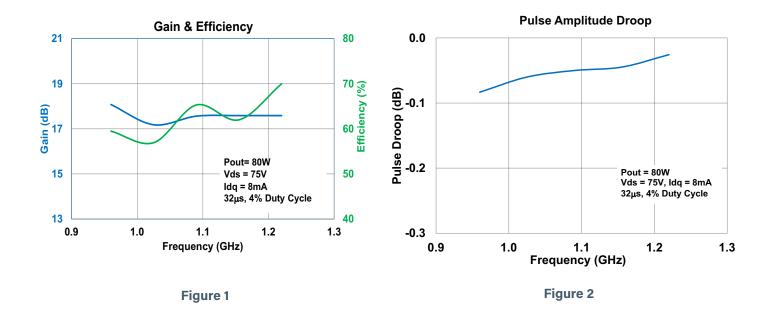
Frequency (MHz)	ZIF	Z <sub>of</sub>	Units	Test Conditions
960	8.38 - j 3.81	12.30 + j 12.09	Ω	P <sub>out</sub> = 80W
1090	8.00 - j 0.05	12.86 + j 10.91	Ω	32µs pulse length, 4% duty cycle $V_{_{\rm DS}}=75V,I_{_{\rm DS}}=8mA$
1220	8.10 + j 1.21	12.35 + j 10.79	Ω	

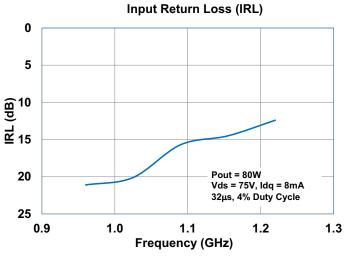


# IGN0912S80HV | RF Power Transistor IGN0912S80HVS



# **TYPICAL RF PERFORMANCE**





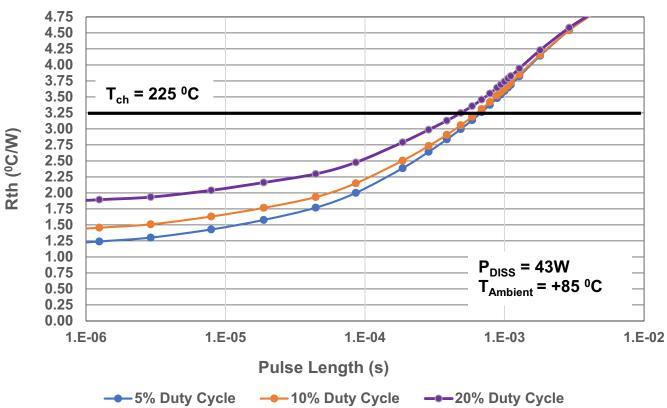




# **TYPICAL THERMAL PERFORMANCE**

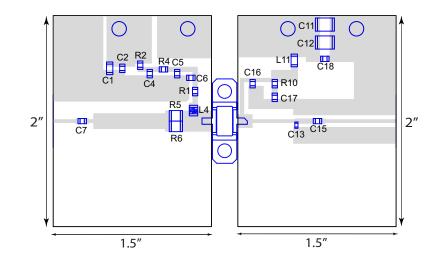
#### Table 5. Thermal Resistance (Case temperature = 85 °C unless otherwise stated)

Parameter	Symbol	Тур	Test Conditions
Peak Thermal Resistance, Channel to Case	R <sub>th</sub>	1.75	$\begin{array}{c} P_{_{\text{DISS}}}=\!43W\\ 32\mu\text{s pulse length, 4% duty cycle}\\ V_{_{\text{DS}}}=75V \end{array}$



# **Thermal Resistance**





# **TEST FIXTURE**

#### Bill of Materials for IGN0912S80HV Test Fixture

Designator	Description	Quantity	Part Number
C1	CAP 1 μF, 100V, 1206, X7R	1	12061C105K4T2A
C2, C5, C18	CAP 1000pF, 100V, 0805	3	08051A102J4T2A
C4, C17	CAP 0.068µF, 250V, 0805, X7R	2	C0805C683KARAC#A
C6, C7, C16	CAP 33pF, 0805	3	600F330FT250XT
C11, C12	CAP 1µF, 200V, 1812, X7R	2	18122C105KAT2A
C13	CAP 1.6pF, 0603, 250V	1	600S1R6AT250XT
C15	CAP 18pF, 0805	1	600F180JT250XT
L4	IND 39nH, 1008	1	1008CS-390XJLB
L11	IND FB 1206, 6A, 33 OHM	1	BLM31PG330SN1L
R1, R10	RES 5.1 OHM, 0805	2	CRCW08055R1JNEA
R2	RES 200 OHM, 0805	1	CRCW0805200RFKTA
R4	RES 0 OHM, 0805	1	CRCW08050000ZSTA
R5, R6	RES 2 OHM, 1210	2	CRCW12102R00JNEA
PC Board Type	ROGERS RO3006, 25mil, 1/1oz. Copper	2	



MAX 5.97

20.44

3.43

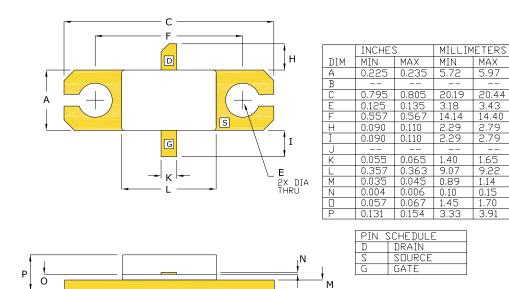
14.40

2.79 2.79

1.65

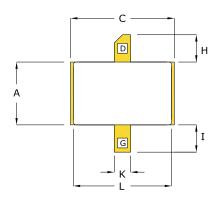
9.22 <u>1.14</u> 0.15 1.70 3.91

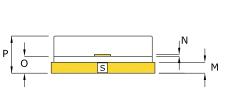
# PACKAGE PL32C2





**IGN0912S80HV** 





	INCHES	2	MILLIM	ETERS
DIM	MIN	MAX	MIN	MAX
А	0.225	0.235	5.72	5,97
В				
С	0.375	0.385	9.53	9,78
Ε				
F				
Н	0.090	0.110	2.29	2,79
Ι	0.090	0.110	2.29	2,79
J				
К	0.055	0.065	1.40	1.65
L	0.357	0.363	9.07	9,22
М	0.035	0.045	0,89	1.14
Ν	0.004	0.006	0,10	0.15
	0.057	0.067	1.45	1.70
Ρ	0.131	0.154	3.33	3.91

PIN S	SCHEDULE
D	DRAIN
S	SOURCE
G	GATE

# **EARLESS FLANGE OPTION IGN0912S80HVS**



#### **ESD & MSL Rating**

Parameter	Rating	Standard
ESD Human Body Model (HBM)	TBD	ESDA/JEDEC JS-001-2012
ESD Charged Device Model (CDM)	TBD	JEDEC JESD22-C101F
Moisture Sensitivty Level (MSL)	Unlimited Shelf Life	IPC/JEDEC J-STD-020

#### **RoHS Compliance**

Integra Technologies, Inc declares that its GaN and LDMOS Transistor Products comply with EU Directive 2011/65/EU on the restriction of the use of certain hazardous substances in electrical and electronic equipment (RoHS2), as adopted by EU member states on January 2, 2013 and amended on March 31, 2015 by EU Directive 2015/863/EU.

#### **REACH Compliance**

Integra Technologies supports EU Regulation number 1907/2006 concerning the Registration, Evaluation, Authorization, and Restriction of Chemicals (REACH) as these apply to Integra semiconductor products, development tools, and shipping packaging.

In support of the REACH regulation, Integra will:

Inform customers and recipients of Integra product if they contain any substances that are of very high concern (SVHC) per the European Chemical Agency (ECHA) website.

•Notify ECHA if any Integra product that contains any SVHCs which exceed guidelines for REACH chemicals by weight per part number and for total content weight per year for all products produced in or imported to the European market.

•Cease shipments of product containing REACH Annex XIV substances until authorization has been obtained.

•Cease shipment of product containing REACH Annex XVII chemicals when restrictions apply.

Integra has evaluated its materials, BOMs, and product specifications and product and has determined that this transistor conforms to all REACH and SVHC regulations and guidelines. Integra has implemented actions and control programs that will assure continued compliance.

#### Disclaimer

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DEFINITIONS:

DATA SHEET STATUS

Advanced Specification - This data sheet contains Advanced specifications.

Preliminary Specification - This data sheet contains specifications based on preliminary measurements and data.

Final Specification - This data sheet contains final product specifications.

MAXIMUM RATINGS Stress above one or more of the maximum ratings may cause permanent damage to the device. These are maximum ratings only operation of the device at these or at any other conditions above those given in the characteristics sections of the specification is not implied. Exposure to maximum values for extended periods of time may affect device reliability. Integra Technologies, 321 Coral Circle, El Segundo, CA 90245-4620 | Phone: 310-606-0855 | Fax: 310-606-0865